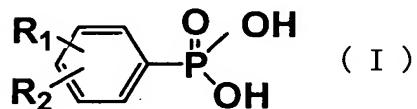


Amendments to the Specification:

Please replace paragraph [0005] with the following rewritten paragraph:

[0005] The object of the present invention is accomplished by the following means. A first aspect of the present invention is a polylactic acid resin composition comprising a polylactic acid resin, and a metal salt of a phosphorus compound of formula (I)

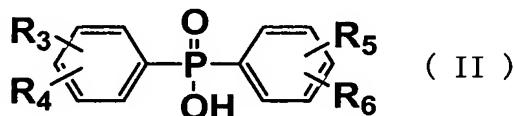


wherein R<sub>1</sub> and R<sub>2</sub> may be the same or different and are hydrogen atom, C<sub>1-10</sub>alkyl or ~~C<sub>1-10</sub>alkoxycarbonyl C<sub>2-10</sub>alkoxycarbonyl~~.

Now, preferred embodiments of the first aspect are as follows.

- the metal salt is one or more selected from the group consisting of lithium salt, sodium salt, potassium salt, calcium salt, magnesium salt and zinc salt;
- the metal salt of the phosphorus compound of formula (I) is contained in an amount of 0.01 to 10.0 mass parts based on 100 mass parts of the polylactic acid resin; and
- the average particle diameter of the metal salt is 0.05 to 10 mm, preferably 0.05 to 5 mm.

A second aspect of the present invention is a polylactic acid resin composition comprising a polylactic acid resin, and a metal salt of a phosphorus compound of formula (II)



wherein R<sub>3</sub>, R<sub>4</sub>, R<sub>5</sub> and R<sub>6</sub> may be the same or different and are hydrogen atom, C<sub>1-10</sub>alkyl or ~~C<sub>1-10</sub>alkoxycarbonyl C<sub>2-10</sub>alkoxycarbonyl~~.

Now, preferred embodiments of the second aspect are as follows.

- the metal salt is one or more selected from the group consisting of lithium salt, sodium salt, potassium salt, calcium salt, magnesium salt and zinc salt;
- the metal salt of the phosphorus compound of formula (II) is contained in an amount of 0.01 to 10.0 mass parts based on 100 mass parts of the polylactic acid resin; and
- the average particle diameter of the metal salt is 0.05 to 10 mm, preferably 0.05 to 5 mm.

Please replace paragraph [0009] with the following rewritten paragraph:

**[0009]** The substituents shown by R<sub>1</sub> and R<sub>2</sub> in formula (I) in the phosphorus compound of the formula of the present invention include hydrogen atom, C<sub>1-10</sub>alkyl such as methyl, ethyl, n-propyl, i-propyl, n-butyl, i-butyl, t-butyl or the like, C<sub>1-10</sub>alkoxycarbonyl-C<sub>2-10</sub>alkoxycarbonyl such as methoxycarbonyl, ethoxycarbonyl or the like. These substituents may be the same or different. Concrete examples are phenyl phosphonic acid, 4-methylphenyl phosphonic acid, 4-ethylphenyl phosphonic acid, 4-n-propylphenyl phosphonic acid, 4-i-propylphenyl phosphonic acid, 4-n-butylphenyl phosphonic acid, 4-i-butylphenyl phosphonic acid, 4-t-butylphenyl phosphonic acid, 3,5-dimethoxycarbonylphenyl phosphonic acid, 3,5-diethoxycarbonylphenyl phosphonic acid, 2,5-dimethoxycarbonylphenyl phosphonic acid, 2,5-diethoxycarbonylphenyl phosphonic acid, or the like.

Please replace paragraph [0010] with the following rewritten paragraph:

**[0010]** The substituents shown by R<sub>3</sub>, R<sub>4</sub>, R<sub>5</sub> and R<sub>6</sub> in formula (II) in the phosphorus compound of the formula of the present invention include hydrogen atom, C<sub>1-10</sub>alkyl such as methyl, ethyl, n-propyl, i-propyl, n-butyl, i-butyl, t-butyl or the like, C<sub>1-10</sub>alkoxycarbonyl-C<sub>2-10</sub>alkoxycarbonyl such as methoxycarbonyl, ethoxycarbonyl or the like. These substituents may be the same or different. Concrete examples are diphenyl phosphinic acid, di-4-methylphenyl phosphinic acid, di-4-ethylphenyl phosphinic acid, di-4-t-butylphenyl

phosphinic acid, di-3,5-dimethoxycarbonylphenyl phosphonic acid, di-3,5-diethoxycarbonylphenyl phosphinic acid, or the like.

Please replace the Abstract with the attached amended Abstract.